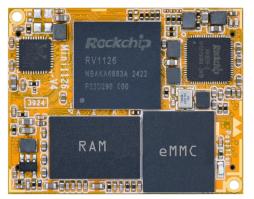
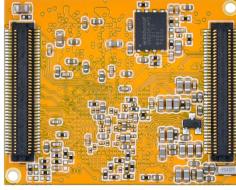


MINI1126

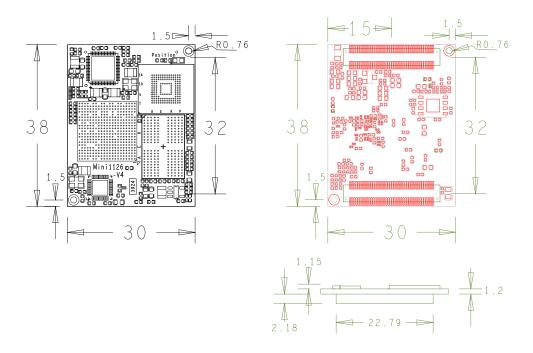
Interface Connection







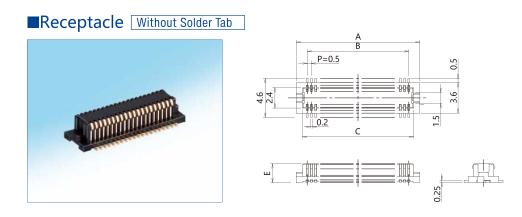
1 PCB Dimension



2 Interface Connection

The <u>EM1126</u> carrier board and core board (<u>MINI1126</u>) is connected via a board-to-board (BTB) double groove connection. The Receptacle *DF12NC(3.0)-80DS-0.5V(51)* is on the CPU board, and the Header *DF12NC(3.0)-80DP-0.5V(51)* on the baseboard.

2.1 Receptacle Specifications



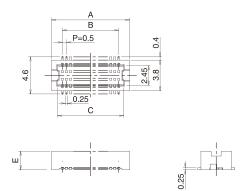
•Stacking Height: 3mm Product							nit : mm		
	Part No.	HRS No.	No. of Pos.	Α	В	С	Е	Remarks	RoHS
	DF12NC(3.0)-80DS-0.5V(51)	537-0285-0 51	80	22.1	19.5	20.6	2.2	Without Solder Tab	YES



2.2 Header Specifications

■Header Without Solder Tab





●Stacking Height: 3mm Product

Unit: mm

- Statiking Holgite: Shimi Hodade										Ome . mm	
	Part No.	HRS No.	No. of Pos.	Α	В	С	E	Remarks	RoHS		
	DF12NC(3.0)-80DP-0.5V(51)	537-0492-0 51	80	22.2	19.5	20.7	2.3	Without Solder Tab	YES		